



Product Change Notification

111213 - 02

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 111213 - 02

Change Title: Intel® Centrino® Wireless-N 100; Intel® Centrino® Wireless-N 130; Intel® Centrino® Advanced-N 6200; Intel® Centrino® Ultimate-N 6300; Intel® Centrino® Wireless-N 1030; Intel® Centrino® Advanced-N 6230; Intel® Centrino® Wireless-N 1000; Intel® Centrino® Advanced-N + WiMAX 6250, and Intel® Centrino® Advanced-N + WiMAX 6150 SKUs: 130BN.HMWG; 130BN.HMWWB; 622AN.HMWG; 622AN.HMWWB; 633AN.HMWG; 633AN.HMWWB; 11230BN.HMWG; 11230BN.HMWWB; 112BN.HMWG; 62230AN.HMWG; 62230AN.HMWWB; 112BN.HMWWB; 112BN.HMWGHF; 612BNXHMWG; 612BNXHMWGGB
PCN 111213-02, Label
Change to label for new Korean Certification Logo
Reason for Revision: Remove SKU not included in change

Date of Publication: March 15, 2012

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jan 16, 2012
Date of First Availability of Post-Conversion Material:	Jan 16, 2012

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this

date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

Reason for Revision: Remove SKU not included in change

1. The new Korean Certification logo will be incorporated on the Intel® Centrino® Wireless-N 130, Intel® Centrino® Advanced-N 6200, Intel® Centrino® Ultimate-N 6300, Intel® Centrino® Wireless-N 1030, Intel® Centrino® Advanced-N 6230, Intel® Centrino® Wireless-N 1000, Intel® Centrino® Advanced-N + WiMAX 6250, and Intel® Centrino® Advanced-N + WiMAX 6150 product labels.
2. The product label material will be changed from polyimide to polyester on Intel® Centrino® Wireless-N 1000 SKU 112BN.HMWG.

Attention: There will be no change for the Product Code 622ANXHMWGBB, Intel® Centrino® Advanced-N + WiMAX 6250 label.

Customer Impact of Change and Recommended Action:

1. The product labels for the Intel® Centrino® Wireless-N 130, Intel® Centrino® Advanced-N 6200, Intel® Centrino® Ultimate-N 6300, Intel® Centrino® Wireless-N 1030, Intel® Centrino® Advanced-N 6230, Intel® Centrino® Wireless-N 1000, Intel® Centrino® Advanced-N + WiMAX 6250, and Intel® Centrino® Advanced-N + WiMAX 6150 will be updated to incorporate the new Korean Certification logo below.



2. The product label material will be changed from polyimide to polyester on Intel® Centrino® Wireless-N 1000 SKU 112BN.HMWG.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only. No change to form, fit or function. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions

**Products Affected / Intel Ordering Codes:
Board Products Label Material Change**

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA or AA	Post-Change TA or AA
112BN.HMWG	903341	903341	E66710-011	E66710-012

Board Products Table Korean Label Change

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA or AA	Post-Change TA or AA
130BN.HMWG	909753	909753	G15170-008	G15170-009
130BN.HMWWB	909813	909813	G14132-005	G14132-006
100BN.HMWG	909752	909752	G17078-008	G17078-009
100BN.HMWWB	909800	909800	G14152-005	G14152-006
622AN.HMWG	903690	903690	E57203-014	E57203-015
622AN.HMWWB	903726	903726	E78588-008	E78588-009
633AN.HMWG	903689	903689	E55085-016	E55085-017
633AN.HMWWB	903725	903725	E78617-007	E78617-008
11230BN.HMWG	907747	907747	G13407-009	G13407-010
11230BN.HMWWB	907750	907750	G23704-006	G23704-007
112BN.HMWWB	903528	903528	E72377-008	E72377-009
112BN.HMWGHF	904990	904990	E76807-009	E76807-010
622ANXHMWG	903743	903743	E62815-014	E62815-015
612BNXHMWG	908945	908945	E98124-005	E98124-006
612BNXHMWGGBB	910777	910777	G18271-004	G18271-005
112BN.HMWG	903341	903341	E66710-012	E66710-013
62230AN.HMWG	907919	907919	G13186-009	G13186-010
62230AN.HMWWB	907942	907942	G23772-005	G23772-006

**Products Not Affected / Intel Ordering Codes:
Board Products Table**

Product Code	MM#	TA or AA
622ANXHMWGGBB	908056	E93514-005

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
December 23, 2011	00	Originally Published PCN
February 27, 2012	01	Show Change per dash of TA for 112BN.HMWG SKU.
March 15, 2012	02	Remove SKU not included in change